



CELANEX® PBT

Chemical abbreviation according to ISO 1043-1: PBT Moulding compound ISO 7792- PBT, MGHR, 08-070N, GF20 Polybutylene terephthalate, 20 % glass fibre reinforced.

Flammability UL 94 HB minimum thickness 1.2 mm.

Recognition by Underwriters Laboratories, USA (UL)

Product information

Resin Identification	PBT-GF20	ISO 1043
Part Marking Code	>PBT-GF20<	ISO 11469

Rheological properties

Melt volume-flow rate	14 cm ³ /10min	ISO 1133
Temperature	250 °C	
Load	2.16 kg	
Moulding shrinkage range, parallel	0.4 - 0.5 %	ISO 294-4, 2577
Moulding shrinkage range, normal	1 - 1.2 %	ISO 294-4, 2577

Typical mechanical properties

'400 MPa	ISO 527-1/-2
125 MPa	ISO 527-1/-2
3 %	ISO 527-1/-2
170 MPa	ISO 178
3 %	ISO 178
200 MPa	ISO 899-1
800 MPa	ISO 899-1
46 kJ/m ²	ISO 179/1eU
43 kJ/m ²	ISO 179/1eU
7.5 kJ/m ²	ISO 179/1eA
7 kJ/m ²	ISO 179/1eA
190 MPa	ISO 2039-1
35 ^[C]	
64	3 % 170 MPa 3 % 6200 MPa 4800 MPa 46 kJ/m² 43 kJ/m² 7.5 kJ/m² 7 kJ/m²

Thermal properties

merma properties		
Melting temperature, 10°C/min	225 °C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	195 °C	ISO 75-1/-2
Temperature of deflection under load, 0.45 MPa	220 °C	ISO 75-1/-2
Temperature of deflection under load, 8 MPa	100 °C	ISO 75-1/-2
Vicat softening temperature, 50°C/h 50N	215 °C	ISO 306
Ball pressure test	210 °C	IEC 60695-10-2
Coefficient of linear thermal expansion	35 E-6/K	ISO 11359-1/-2
(CLTE), parallel		
Thermal conductivity of melt	0.156 W/(m ł	() ISO 22007-2
Specific heat capacity of melt	1840 J/(kg k	() ISO 22007-4

Printed: 2025-05-30 Page: 1 of 9





CELANEX® PBT

Flammability

Burning Behav. at 1.5mm nom. thickn.	НВ	class	IEC 60695-11-10
Thickness tested	1.5	mm	IEC 60695-11-10
Burning Behav. at thickness h	HB	class	IEC 60695-11-10
Thickness tested	1	mm	IEC 60695-11-10
UL recognition	yes		UL 94
Oxygen index	20	%	ISO 4589-1/-2
FMVSS Class	В		ISO 3795 (FMVSS 302)

Electrical properties

Relative permittivity, 100Hz	4.2	IEC 62631-2-1
Relative permittivity, 1MHz	4.1	IEC 62631-2-1
Dissipation factor, 100Hz	16 E-4	IEC 62631-2-1
Dissipation factor, 1MHz	190 E-4	IEC 62631-2-1
Volume resistivity	>1E13 Ohm.m	IEC 62631-3-1
Surface resistivity	>1E15 Ohm	IEC 62631-3-2
Electric strength	31 kV/mm	IEC 60243-1
Comparative tracking index	350	IEC 60112

Physical/Other properties

Humidity absorption, 2mm	0.15 %	Sim. to ISO 62
Water absorption, 2mm	0.4 %	Sim. to ISO 62
Density	1450 kg/m³	ISO 1183
Density of melt	1230 kg/m ³	

Injection

Drying Recommended	yes	
Drying Temperature	120	°C
Drying Time, Dehumidified Dryer	4	h
Processing Moisture Content	≤0.02	%
Melt Temperature Optimum	250	°C
Min. melt temperature	240	°C
Max. melt temperature	260	°C
Screw tangential speed	0.1 - 0.3	m/s
Mold Temperature Optimum	80	°C
Min. mould temperature	60	°C
Max. mould temperature	130	°C
Ejection temperature	220	°C

Characteristics

Processing Injection Moulding

Delivery form Pellets

Additives Release agent

Special characteristics Heat stabilised or stable to heat

Printed: 2025-05-30 Page: 2 of 9





CELANEX® PBT

Additional information

Injection molding

Preprocessing

To avoid hydrolytic degradation during processing, CELANEX resins have to be dried to a moisture level equal to or less than 0,02%. The drying should be done in a dry-air dryer (dew point < -30 °C) with a temperature of 120 to 140 °C and a drying time of 2 to 4 hours. In case of longer residence times in the dry-air dryer, the temperature should be reduced to 100 °C.

The time between drying and processing should be kept as short as possible. The processing machine feed hopper should be closed during the processing operation.

Processing

Melt Temperature 260-270 °C
Mold Temperature *) 75-85 °C
Maximum Barrel Residence Time **) 5-10 min
Injection Speed fast
Peripheral screw speed max.0,3 m/sec
Back Pressure 10-30 bar
Injection Pressure 600-1000 bar
Holding Pressure 400-800 bar
Nozzle Design open design preferred

Injection speed, injection pressure and holding pressure have to be optimized to the individual article geometry. To avoid material degradation during processing low back pressure and minimum screw speed have to be used. Overheating of the material has to be avoided. For grades containing flame retardants, a maximum temperature of 265 °C should not be exceeded.

Celanese recommends only externally heated hot runner systems.

- *) For moulded parts with especially high requirements to the surface quality or dimensional stability, a mold temperature of up to 110 °C can be advantageous.
- **) If the cylinder temperatures are higher than the recommended maximum temperatures, the max. residence time in the barrel has to be reduced.

Processing Notes

Pre-Drying

CELANEX should in principle be predried. Because of the necessary low maximum residual moisture content the use of dry air dryers is recommended. The dew point should be =< - 30° C. The time between drying and processing should be as short as possible.

Storage

For subsequent storage of the material in the dryer until processed (<= 60 h) it is

Printed: 2025-05-30 Page: 3 of 9





CELANEX[®] 2300 GV1/20

CELANEX® PBT

necessary to lower the temperature to 100° C.

2021 (V2)

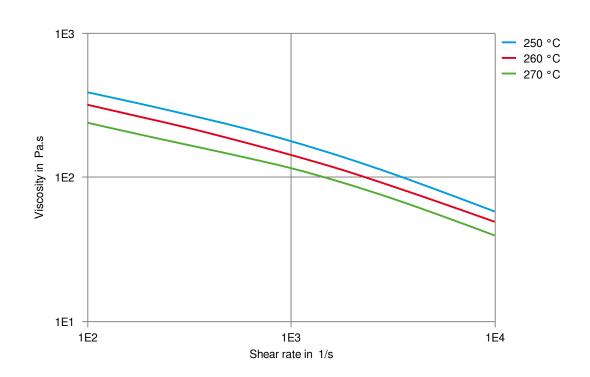
Automotive

OEMSTANDARDADDITIONAL INFORMATIONBoschN28 BN07-GF014NaturalBoschN28 BN07-GF014BlackBoschN28 BN07-GF014NiederzissenContinentalSN 57908-7

Li Auto Q/LiA5310038

VW Group VW 50136

Viscosity-shear rate



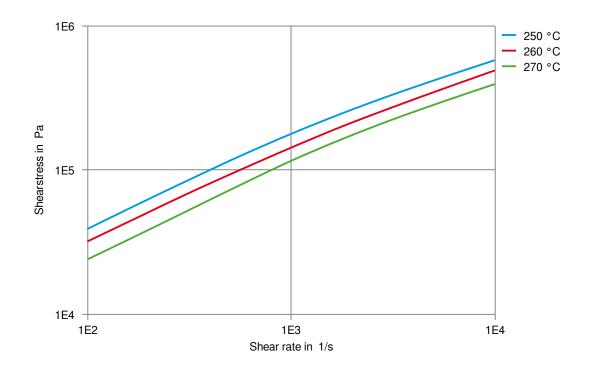
Printed: 2025-05-30 Page: 4 of 9





CELANEX® PBT

Shearstress-shear rate



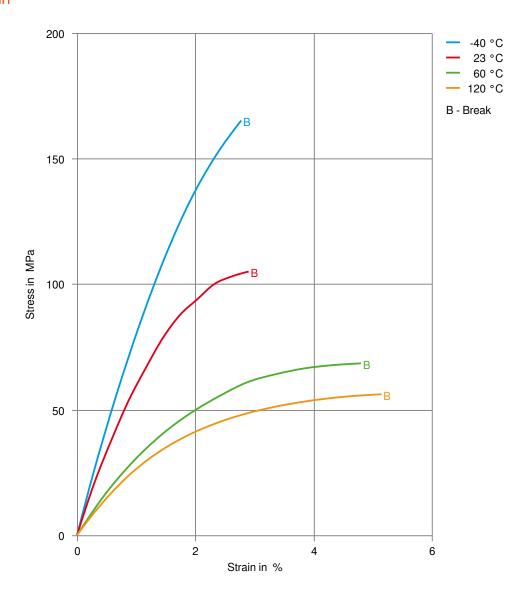
Printed: 2025-05-30 Page: 5 of 9





CELANEX® PBT

Stress-strain



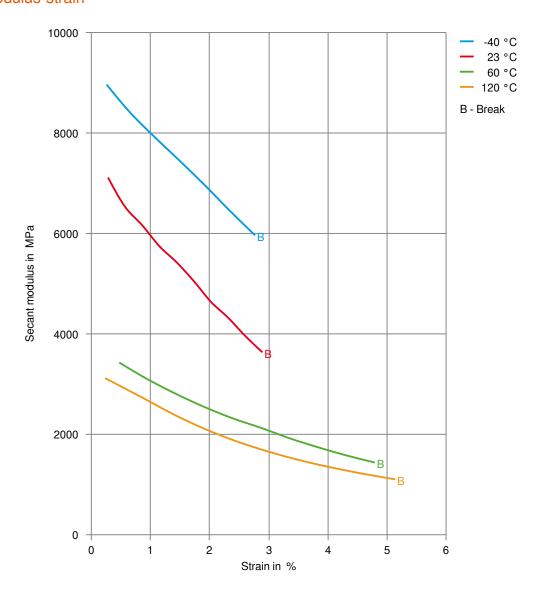
Printed: 2025-05-30 Page: 6 of 9





CELANEX® PBT

Secant modulus-strain



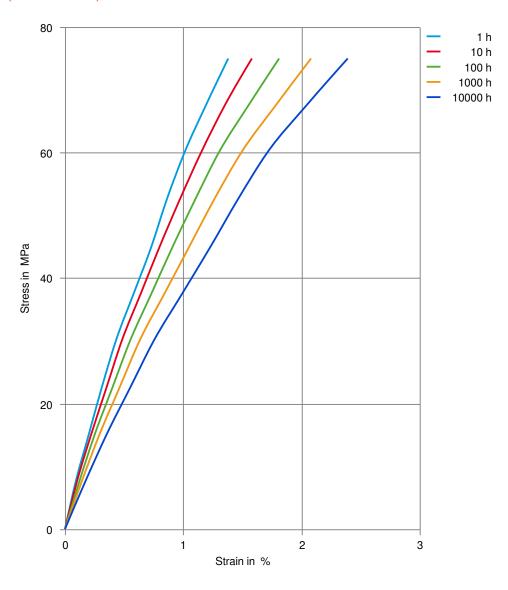
Printed: 2025-05-30 Page: 7 of 9





CELANEX® PBT

Stress-strain (isochronous) 23°C



Printed: 2025-05-30 Page: 8 of 9

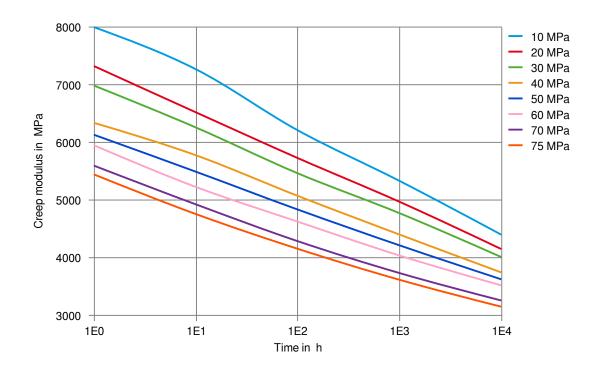




CELANEX[®] 2300 GV1/20

CELANEX® PBT

Creep modulus-time 23°C



Printed: 2025-05-30 Page: 9 of 9

Revised: 2025-05-16 Source: Celanese Materials Database

NOTICE TO USERS: Values shown are based on testing of laboratory test specimens and represent data that fall within the standard range of properties for natural material. These values alone do not represent a sufficient basis for any part design and are not intended for use in establishing maximum, minimum, or ranges of values for specification purposes. Colourants or other additives may cause significant variations in data values. Properties of moulded parts can be influenced by a wide variety of factors including, but not limited to, material selection, additives, part design, processing conditions and environmental exposure. Other than those products expressly identified as medical grade (including by MT® product designation or otherwise), Celanese's products are not intended for use in medical or dental implants. Regardless of any such product designation, any determination of the suitability of a particular material and part design for any use contemplated by the users and the manner of such use is the sole responsibility of the users, who must assure themselves that the material as subsequently processed meets the needs of their particular product or use. To the best of our knowledge, the information contained in this publication is accurate; however, we do not assume any liability whatsoever for the accuracy and completeness of such information. The information contained in this publication should not be construed as a promise or guarantee of specific properties of our products. It is the sole responsibility of the users to investigate whether any existing patents are infringed by the use of the materials mentioned in this publication. Moreover, there is a need to reduce human exposure to many materials to the lowest practical limits in view of possible adverse effects. To the extent that any hazards may have been mentioned in this publication, we neither suggest nor guarantee that such hazards are the only ones that exist. We recommend that persons intending to rely on any recommendation or to use any e

© 2025 Celanese or its affiliates. All rights reserved. Celanese®, registered C-ball design and all other trademarks identified herein with ®, TM, SM, unless otherwise noted, are trademarks of Celanese or its affiliates. Fortron is a registered trademark of Fortron Industries LLC.